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MARK OFFICE Docket No.: VLSI-3513

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	<ol> <li>Name and Address of PHILIPS Electronics North American Corporation Receiving party(ies) 1251 Avenue of the Americas, New York, New York 10020-1104 Texas Instruments Incorporated 7839 Churchill Way, MS 3999, Dallas, Texas 75251</li> <li>Nature of Conveyance: Assignment</li> </ol>											
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Page 1 of 1

rev. 6/97 jpw

PATENT REEL: 011553 FRAME: 0685

## Assignment to PHILIPS Electronics North American Corporation and Texas Instruments Incorporated

In consideration of good and valuable consideration, receipt of which is hereby acknowledged. I/we

Luis Aldaz

do hereby sell, assign and transfer unto PHILIPS Electronics North American Corporation (hereinafter called PHILIPS), a Delaware Corporation having its principal place of business at 1251 Avenue of the Americas. New York, New York 10020-1104, and Texas Instruments Incorporated (hereinafter called TI), a Delaware Corporation having its principal place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251 and their successors and assigns, the equal and undivided right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

METHOD AND APPARATUS FOR COMBINED FINGER MANAGEMENT AND FINGER LOCK FOR A MULTIPATH SIGNALS IN A WIRELESS COMMUNICATION SYSTEM

filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore; or

X Serial No.: 09/678,480 filed on 10/02/00 and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore;

And for the above consideration, I/we agree promptly upon request of PHILIPS and TI, its successors or assigns. to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to PHILIPS and TI, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by PHILIPS and TI;

I/we further covenant with PHILIPS and TI, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

In witness whereof, I/we here	unto set my/our hand(s) a	ind seal.		
Inventor's Signature:	1///		Date: ×2//•/•/	
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rev. 12/00 dmc

## Assignment to PHILIPS Electronics North American Corporation and Texas Instruments Incorporated

In consideration of good and valuable consideration, receipt of which is hereby acknowledged. I/we

Gibong Jeong

..... do hereby sell, assign and transfer unto PHILIPS Electronics North American Corporation (hereinafter called PHILIPS), a Delaware Corporation having its principal place of business at 1251 Avenue of the Americas, New York, New York 10020-1104, and Texas Instruments Incorporated (hereinafter called TI), a Delaware Corporation having its principal place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251 and their successors and assigns, the equal and undivided right, title, and interest for the United States and all foreign countries. in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

METHOD AND APPARATUS FOR COMBINED FINGER MANAGEMENT AND FINGER LOCK FOR A MULTIPATH SIGNALS IN A WIRELESS COMMUNICATION SYSTEM

- filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore: or
- x Serial No.: <u>09/678,480</u> filed on <u>10/02/00</u> and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore;

And for the above consideration, I/we agree promptly upon request of PHILIPS and TI, its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to PHILIPS and TI, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by PHILIPS and TI;

I/we further covenant with PHILIPS and TI, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

Inventor's Signature: \_\_\_\_\_\_\_\_\_\_Date: \_\_\_\_\_\_\_Date: \_\_\_\_\_\_\_\_

rev. 12/00 dmc

#### Assignment to PHILIPS Electronics North American Corporation and Texas Instruments Incorporated

In consideration of good and valuable consideration, receipt of which is hereby acknowledged. I/we

Daniel Jeng Hsia do hereby sell, assign and transfer unto PHILIPS Electronics North American Corporation (hereinafter called PHILIPS), a Delaware Corporation having its principal place of business at 1251 Avenue of the Americas, New York, New York 10020-1104, and Texas Instruments Incorporated (hereinafter called TI), a Delaware Corporation having its principal place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251 and their successors and assigns, the equal and undivided right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

METHOD AND APPARATUS FOR COMBINED FINGER MANAGEMENT AND FINGER LOCK FOR A MULTIPATH SIGNALS IN A WIRELESS COMMUNICATION SYSTEM

filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore; or

X Serial No.: 09/678,480 filed on 10/02/00 and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore:

And for the above consideration, I/we agree promptly upon request of PHILIPS and TI, its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to PHILIPS and TI, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by PHILIPS and TI;

I/we further covenant with PHILIPS and TI, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned:

In witness whereof, I/we hereunto set my/our hand(s) and seal.

Inventor's Signature: Daniel J. A. Date: 1/2/01

Docket No.: VLSI-3513

### Assignment to PHILIPS Electronics North American Corporation and Texas Instruments Incorporated

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we

Juncheng C. Liu

do hereby sell, assign and transfer unto PHILIPS Electronics North American Corporation (hereinafter called PHILIPS), a Delaware Corporation having its principal place of business at 1251 Avenue of the Americas, New York, New York 10020-1104, and Texas Instruments Incorporated (hereinafter called TI), a Delaware Corporation having its principal place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251 and their successors and assigns, the equal and undivided right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

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I/we further covenant with PHILIPS and TI, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

In witness whereof, I/we hereunto set my/our hand(s) and seal.

Inventor's Signature: Junchang C. tim Date: Ducto, 2000

rev. 12/00 dmc

Page 1 of 1

Docket No.: VLSI-3513

# Assignment to PHILIPS Electronics North American Corporation and Texas Instruments Incorporated

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we

Greg Luker

do hereby sell, assign and transfer unto PHILIPS Electronics North American Corporation (hereinafter called PHILIPS), a Delaware Corporation having its principal place of business at 1251 Avenue of the Americas, New York, New York 10020-1104, and Texas Instruments Incorporated (hereinafter called TI), a Delaware Corporation having its principal place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251 and their successors and assigns, the equal and undivided right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

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In witness whereof, I/we hereunto set my/our hand(s) and seal.

Inventor's Signature:	Sy he	Date: < 2/15/2001
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Page 1 of 1

rev. 12/00 dmc

PATENT REEL: 011553 FRAME: 0690

**RECORDED: 02/26/2001**